

### Features

- High Output Power: Psat=52.0dBm (Typ.)
- High Gain: Gp=10.0dB (Typ.)
- High Power Added Efficiency: PAE=38% (Typ.)
- Broad Band: 9.3 to 9.5GHz
- Impedance Matched Zin/Zout = 50ohm
- Hermetically Sealed Package

### Description

The SGC9395-130A-R is a high power GaN-HEMT that is internally matched for X-band radar bands to provide optimum power and gain in a 500hm system.



### ABSOLUTE MAXIMUM RATING (Case Temperature T<sub>c</sub>=25 deg.C)

Item	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	55	V
Gate-Source Voltage	V <sub>GS</sub>	-15	V
Storage Temperature	T <sub>stg</sub>	-55 to +125	deg.C
Channel Temperature	T <sub>ch</sub>	+250	deg.C

### **RECOMMENDED OPERATING CONDITION**

Item	Symbol	Condition	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>		<=50	V	
Forward Gate Current	$I_{GF}$	Rg=20ohm	<=93.6	mA	
Reverse Gate Current	I <sub>GR</sub>	Rg=20ohm	>=-6.8	mA	
Channel Temperature	T <sub>ch</sub>		<+200	deg.C	

#### ELECTRICAL CHARACTERISTICS (Case Temperature T<sub>c</sub>=25 deg.C)

Item	Symbol	Condition		Limit		
	Symbol		Min.	Тур.	Max.	Unit
Pinch-off Voltage	V <sub>P</sub>	$V_{DS}$ =50V, $I_{DS}$ =10.0mA	-	-4.5	-	V
Frequency Range	Freq.	V <sub>DS</sub> =50V-Typ.	9.3	-	9.5	GHz
Output Power	P <sub>sat</sub>	I <sub>DS(DC)</sub> =0.5A-Typ.	51.1	52.0	-	dBm
Power Gain	G <sub>P</sub>	Pulse Width=100µsec.	9.1	10.0	-	dB
Drain Current	I <sub>DSR</sub>	Duty=10%	-	7.5	9.3	A
Power Added Efficiency	PAE	Pin=42dBm	-	38	-	%
Thermal Resistance	R <sub>th</sub>	Channel to Case (P <sub>diss</sub> =100W, CW)	-	1.2	1.5	deg.C/W
		•				

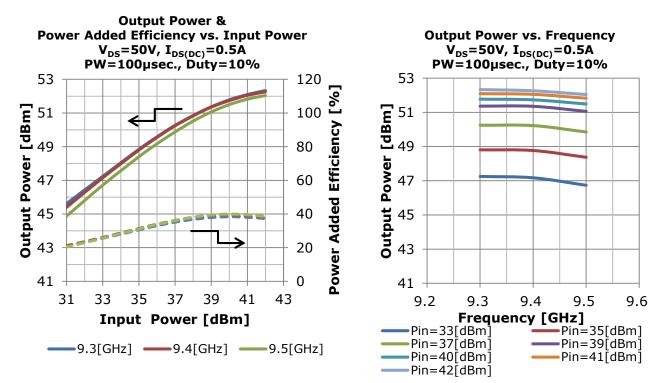
CASE STYLE	IK	
RoHS Compliance	YES	
ESD	Class 2	2000V to <4000V

Note: Based on ANSI/ESDA/JEDEC JS-001-2012(C=100pF, R=1.5kohm)

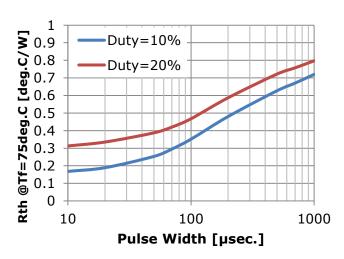


# SGC9395-130A-R X-band Internally Matched GaN-HEMT

## • **RF** Characteristics

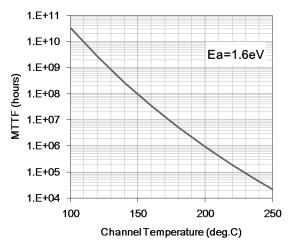


• Thermal Characteristics In Pulsed Operation



Rth vs. Pulse Width

MTTF vs. Tch

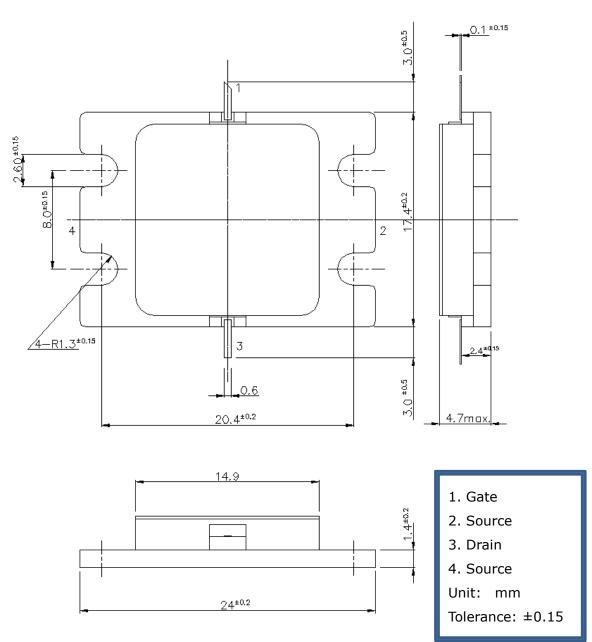




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## • Package Outline

Case Style : IK





## For Safety, Observe the Following Procedures Environmental Management

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product. This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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